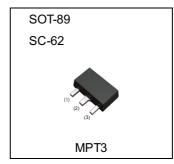


NPN 100mA 400V Middle Power Transistor

Parameter	Value
V _{CEO}	400V
I _C	100mA

Outline

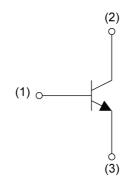


Features

- 1)Complementary PNP Types:2SAR340P
- 2)Low V_{CE(sat)}

 $V_{CE(sat)}$ =300mV(Max) (I_C/I_B =20mA/2mA)

•Inner circuit



- (1) Base
- (2) Collector
- (3) Emitter

Application

LOW FREQUENCY AMPLIFIER

Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Quantity (pcs)	Marking
2SCR346P	SOT-89 (MPT3)	4540	T100	180	12	1000	HK

● Absolute maximum ratings (T_a = 25°C)

Parameter	Symbol	Values	Unit
Collector-base voltage	V_{CBO}	400	V
Collector-emitter voltage	V _{CEO}	400	V
Emitter-base voltage	V _{EBO}	7	V
Calle atom a visita at	I _C	100	mA
Collector current	I _{CP} *1	200	mA
Base current	I _B	30	mA
Daniel dia dia dia dia	P _D *2	0.5	W
Power dissipation	P _D *3	2.0	W
Junction temperature	T _j	150	°C
Range of storage temperature	T _{stg}	-55 to +150	°C

● Electrical characteristics (T_a = 25°C)

Parameter	Symbol Conditions —		Values			Unit
Parameter			Min.	Тур.	Max.	Orill
Collector-base breakdown voltage	BV _{CBO}	I _C = 100μA	400	-	1	V
Collector-emitter breakdown voltage	$ BV_{CFO} $ $ IC $		400	1	1	V
Emitter-base breakdown voltage BV _E		I _E = 100μA	7	1	1	٧
Collector cut-off current		V _{CB} = 400V	ı	ı	10	μA
Emitter cut-off current	I _{EBO}	V _{EB} = 6V	ı	ı	10	μA
Collector-emitter saturation voltage	V _{CE(sat)}	$I_C = 20 \text{mA}, I_B = 2 \text{mA}$	ı	100	300	mV
DC current gain	h _{FE}	V _{CE} = 10V, I _C = 10mA	82	ı	270	-
Output capacitance C _{ob}		$V_{CB} = 10V$, $I_E = 0A$, $f = 1MHz$	ı	6	ı	pF

hFE values are calssified as follows:

rank	Р	Q	-	-	-
h _{FE}	82-180	120-270	-	-	-

^{*1} Pw=10ms Single Pulse

^{*2} Each terminal mounted on a reference land.

^{*3} Mounted on a 40×40×0.7mm ceramic board.

● Electrical characteristic curves(T_a = 25°C)

Fig.1 Grounded Emitter Propagation Characteristics

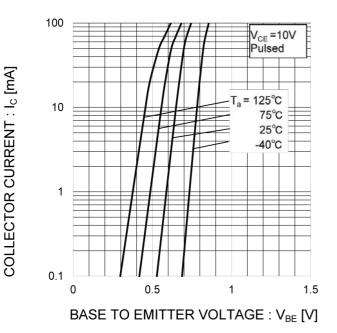
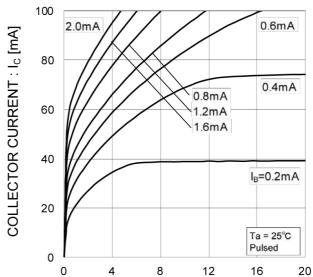


Fig.2 Typical Output Characteristics



COLLECTOR TO EMITTER VOLTAGE: V_{CE} [V]

Fig.3 DC Current Gain vs Collector Current(I)

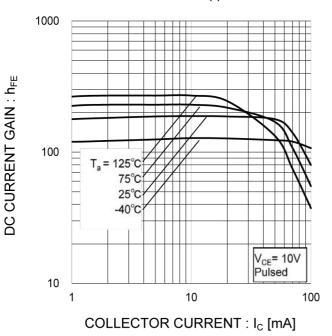
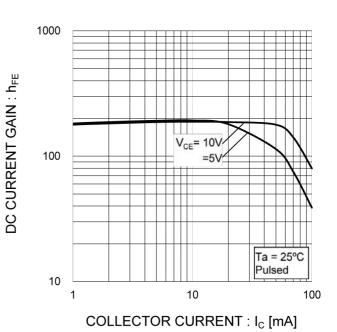


Fig.4 DC Current Gain vs Collector Current(II)



● Electrical characteristic curves(T_a = 25°C)

Fig.5 Collector-Emitter Saturation Voltage vs.Collector-Emitter Saturation Voltage vs. Collector Current(I)

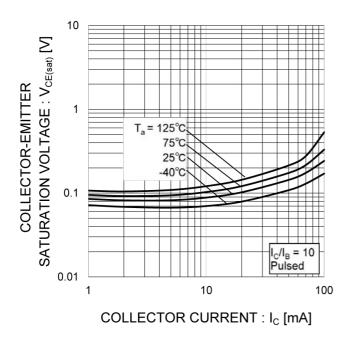


Fig.6 Collector-Emitter Saturation Voltage vs.Collector-Emitter Saturation Voltage vs. Collector Current(II)

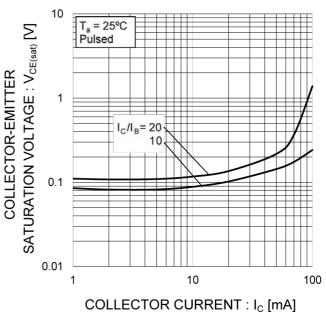


Fig.7 Base-Emitter Saturation Voltage vs. Collector Current

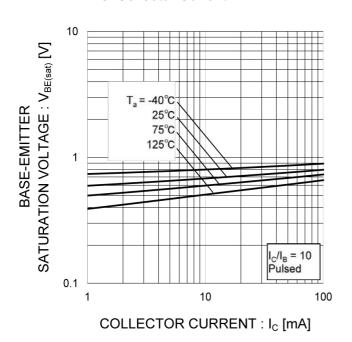
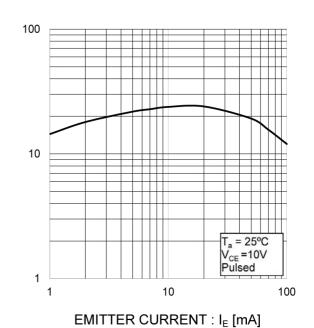


Fig.8 Gain Bandwidth Product vs. Emitter Current



TRANSITION FREQUENCY : fr [MHz]

● Electrical characteristic curves(T_a = 25°C)

Fig.9 Emitter input capacitance
vs. Emitter-Base Voltage
Collector output capacitance
vs. Collector-Base Voltage

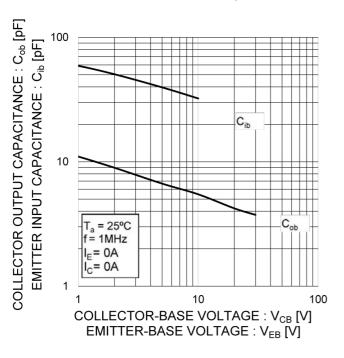
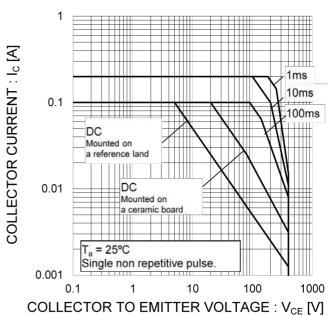
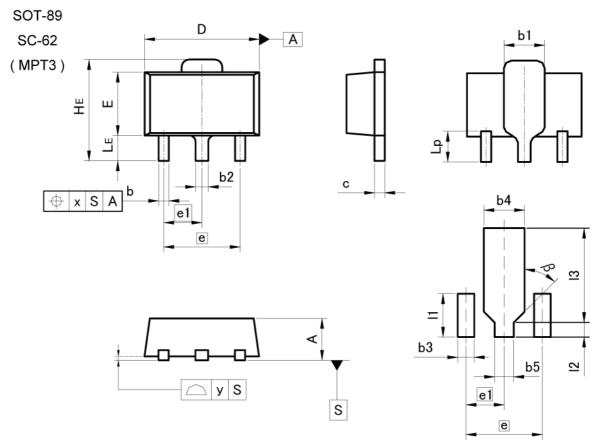


Fig.10 Safe Operating Area



Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM -	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	1.40	1.50	0.055	0.059
b	0.30	0.50	0.012	0.020
b1	1.50	1.70	0.059	0.067
b2	0.40	0.60	0.016	0.024
С	0.35	0.50	0.014	0.020
D	4.40	4.70	0.173	0.185
E	2.40	2.70	0.094	0.106
е	3.00		0.1	18
e1	1.3	50	0.0	59
HE	3.70	4.30	0.146	0.169
LE	0.80	1.20	0.031	0.047
Lp	1.01	1.41	0.040	0.056
х	0-0	0.15		0.006
У	(B)	0.10	83	0.004

DIM	MILIM	ETERS	INC	HES
MIN		MAX	MIN	MAX
b3	EE.	0.65		0.026
b4	1-1	1.70	<u> 20</u>	0.067
b5	i — i	0.75	- 3	0.030
11	(=)	1.71	227	0.067
12	1-1	0.58	=	0.023
13	(0 <u>_</u> 0)	3.72	23	0.146
В	45°		45	

Dimension in mm/inches



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(Note1) Medical Equipment Classification of the Specific Applications

JAPAN	USA	EU	CHINA
CLASSⅢ	CLASSⅢ	CLASS II b	CI ACCIII
CLASSIV	CLASSIII	CLASSⅢ	CLASSIII

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 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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